

# Specification Datasheet

## Ergon COB 1812HO

- 22.5W maximum power capability
- High brightness LED
- Dimension : 17.85 x 17.85 x 1.70 mm
- Precondition : JEDEC Level 2a
- Lead-free reflow soldering application
- RoHS compliant

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## 1. Product description

### (1) Description

- The Ergon series LED is designed for the high power operation to get the high flux output applications.
- It is ideal for the light source for general illumination applications, custom designed solutions.

### (2) Features

- Maximum drive current up to 600mA
- Low thermal resistance as low as 2.5°C/W
- Viewing angle of 115 degrees
- Precondition JEDEC Level 2a
- RoHS compliant

### (3) Applications

- Indoor lighting, Outdoor lighting, Industrial lighting

## 2. Absolute maximum ratings

Parameters	Symbol	Value	Unit
Power dissipated	Pd	22.5	W
Rated forward current	If	600	mA
Maximum junction temperature capability(1)	Tj	125	°C
Operating temperature	Top	- 40 ~ +85	°C
Storage temperature	Tst	- 40 ~ +100	°C

- (1) Proper current derating must be observed to maintain junction temperature below the maximum.

**3. Electro-optical characteristics (Tj=85°C)**

Parameters	Symbol	If(mA)	Typ.	Unit
Forward voltage	Vf	330	34.0	V
Viewing angle FWHM	2θ1/2	330	115	degrees
Thermal resistance junction to solder pad	Rthj-a		2.5	°C/W

- Lumens maintains a tolerance of ±3% on forward voltage measurements.

**4. Electro-optical chart (Tj=85°C)**

CCT(K)	CRI	If(mA)	Vf(V)	Pd(W)	Typ. Φv(lm)	lm/W
2700	80	330	34.0	11.2	1465	130.5
3000		330	34.0	11.2	1505	134.2
3500		330	34.0	11.2	1538	137.1
4000		330	34.0	11.2	1592	141.9
5000		330	34.0	11.2	1615	143.9
5700		330	34.0	11.2	1587	141.5
2700	90	330	34.0	11.2	1219	108.6
3000		330	34.0	11.2	1252	111.6
3500		330	34.0	11.2	1280	114.1
4000		330	34.0	11.2	1325	118.1
5000		330	34.0	11.2	1343	119.7

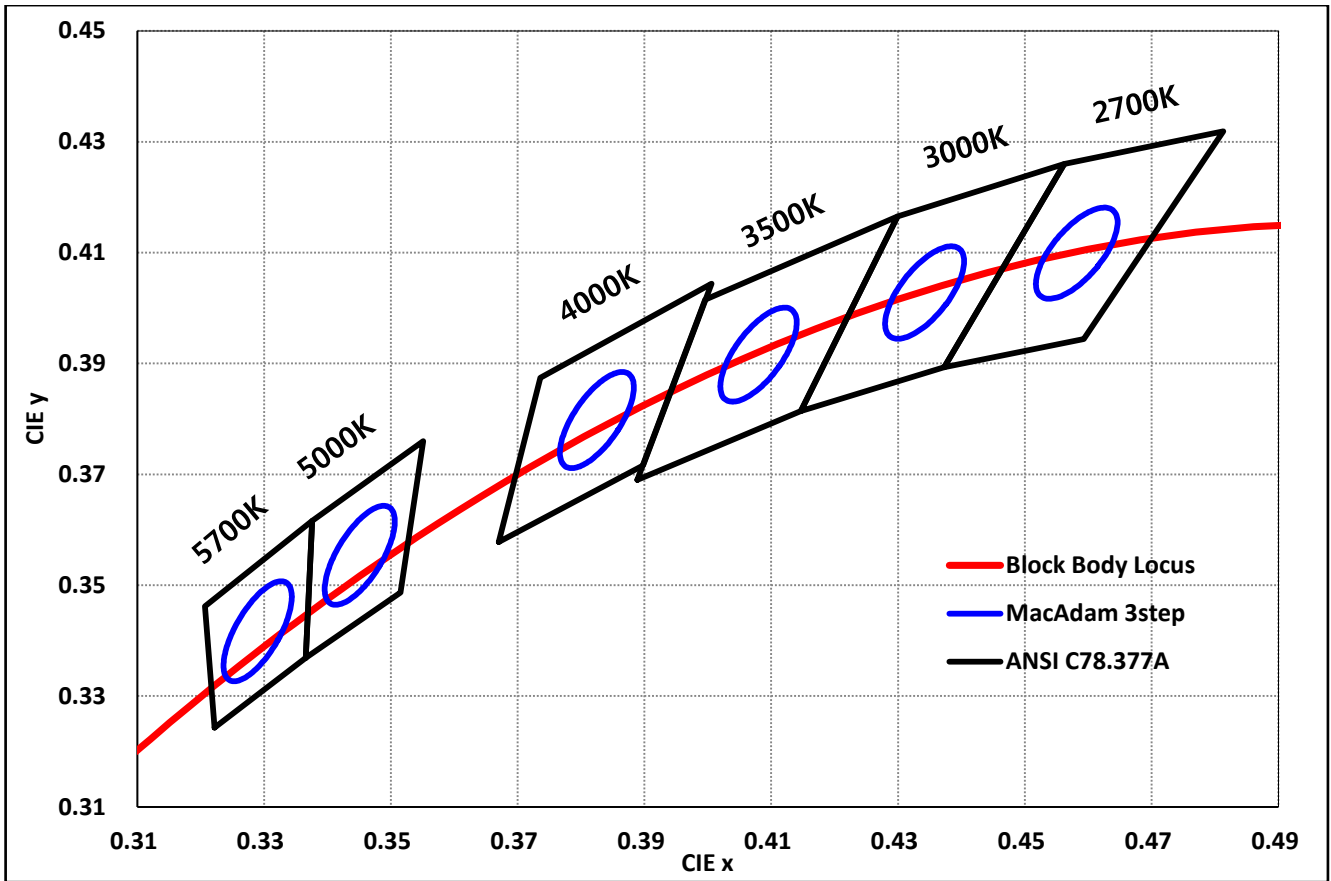
- Lumens maintains a tolerance of ±7% on flux measurements.
- Lumens maintains a tolerance of ±3% on forward voltage measurements.
- Lumens maintains a tolerance of ±2 on CRI measurements.

## 5. Ranks

Item	Symbol	CCT(K)	Min.	Typ.	Unit	CRI	If(mA)			
Luminous Flux	$\Phi_v$	2700	1318	1465	lm	80	330			
		3000	1355	1505	lm					
		3500	1384	1538	lm					
		4000	1433	1592	lm					
		5000	1453	1615	lm					
		5700	1429	1587	lm					
		2700	1097	1219	lm	90				
		3000	1127	1252	lm					
		3500	1152	1280	lm					
		4000	1192	1325	lm					
		5000	1209	1343	lm					
		5700	1209	1343	lm					
		Forward Voltage	Vf	-	31.0	34.0		V	-	

- Lumens maintains a tolerance of  $\pm 7\%$  on flux measurements.
- Lumens maintains a tolerance of  $\pm 3\%$  on forward voltage measurements.
- Lumens maintains a tolerance of  $\pm 2$  on CRI measurements.

6. Chromaticity diagram & coordinates



- Lumens maintains a tolerance of  $\pm 0.005$  on chromaticity (CCx, CCy)

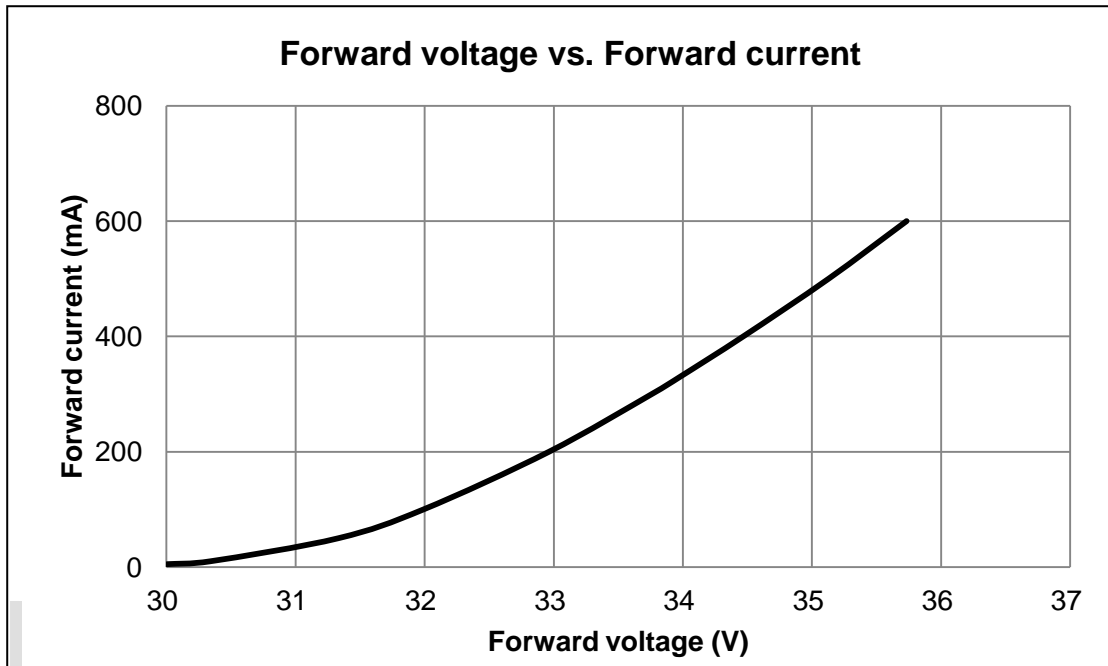
CCT(K)	x	y	CCT(K)	x	y	CCT(K)	x	y
5700K	0.3222	0.3243	4000K	0.3670	0.3578	3000K	0.4147	0.3814
	0.3207	0.346		0.3736	0.3874		0.4299	0.4165
	0.3376	0.3616		0.4006	0.4044		0.4562	0.4260
	0.3366	0.3369		0.3898	0.3716		0.4373	0.3893
5000K	0.3366	0.3369	3500K	0.3889	0.3690	2700K	0.4373	0.3893
	0.3376	0.3616		0.3996	0.4015		0.4562	0.4260
	0.3551	0.3760		0.4299	0.4165		0.4813	0.4319
	0.3515	0.3487		0.4147	0.3814		0.4593	0.3944

\* 3-step MacAdam Ellipse Color Definition

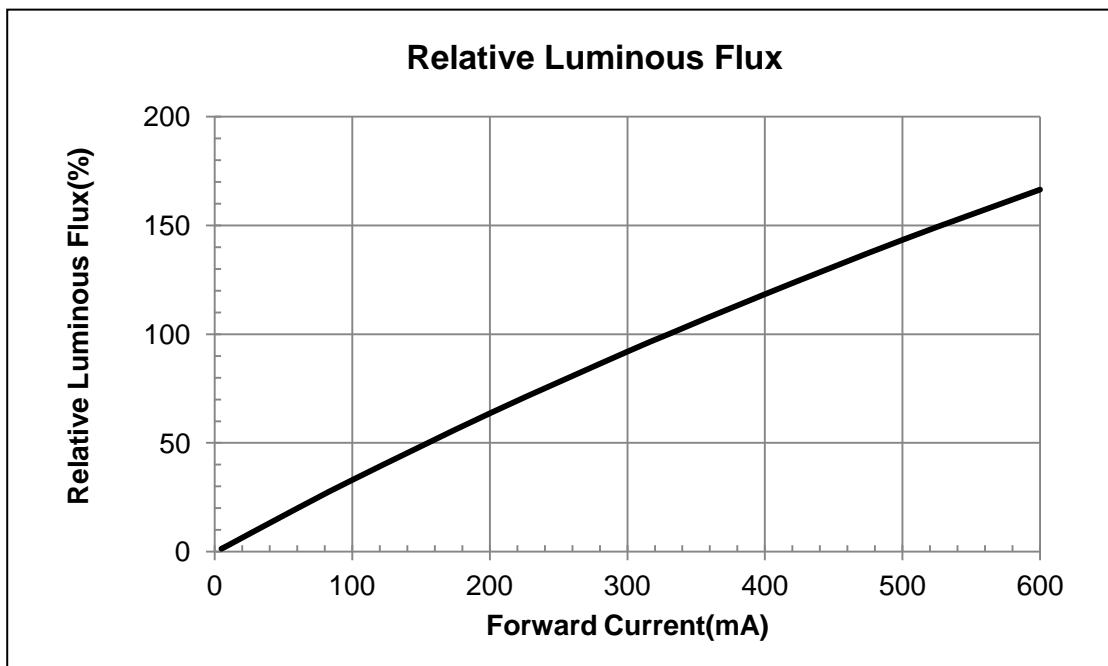
CCT(K)	Center		Ellipse Parameter		
	x	y	Axis a	Axis b	Angle(°)
5700K	0.3287	0.3417	0.00745	0.00320	59.1
5000K	0.3447	0.3553	0.00822	0.00354	59.6
4000K	0.3818	0.3797	0.00939	0.00402	53.7
3500K	0.4073	0.3917	0.00927	0.00414	54.0
3000K	0.4338	0.4030	0.00834	0.00408	53.2
2700K	0.4578	0.4101	0.00810	0.00420	53.7

### 7. Characteristic Graphs(Tj=85°C)

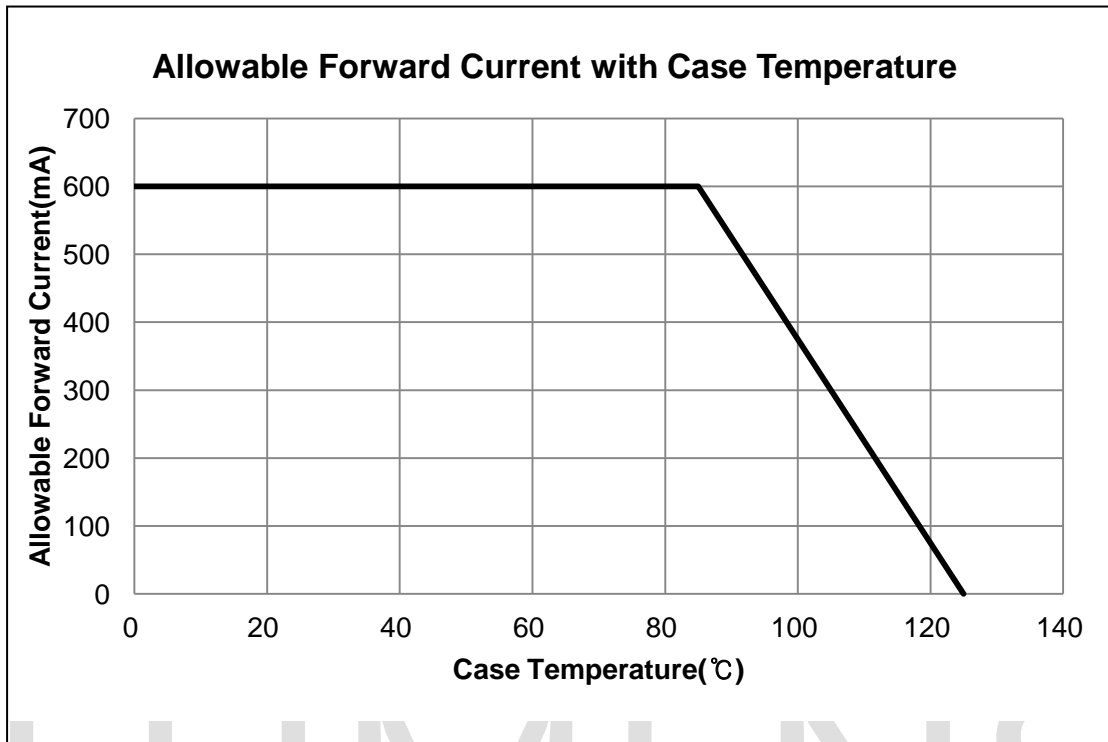
(1) Typical Forward Current vs. Forward Voltage



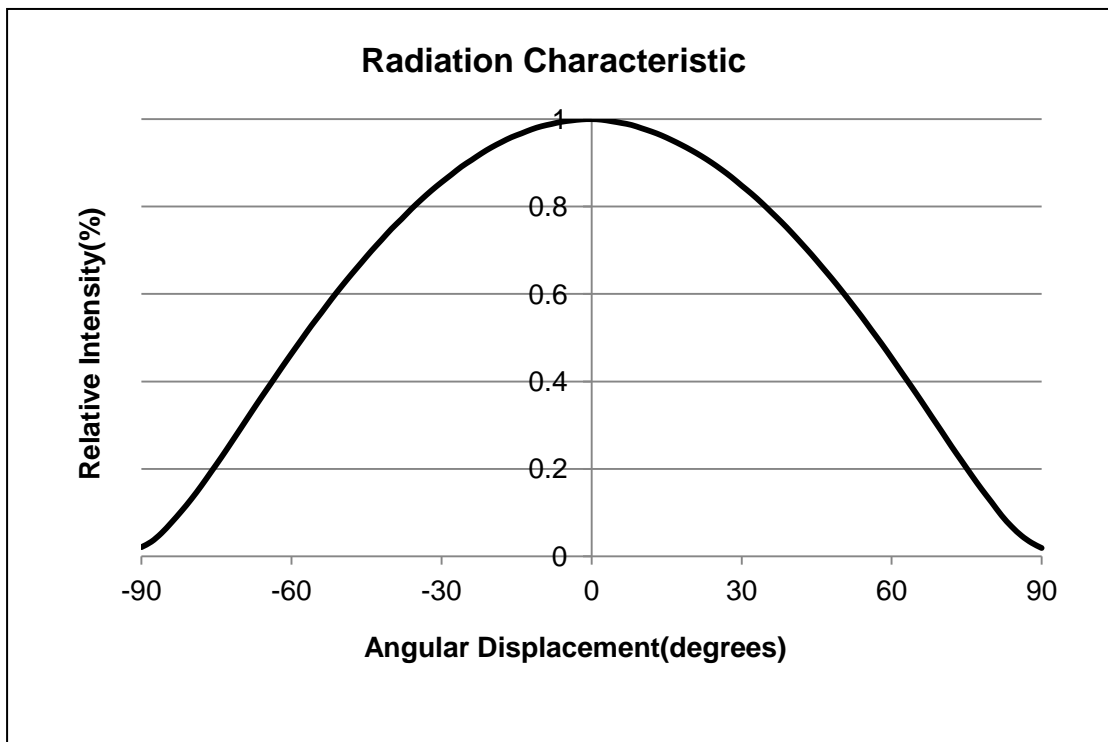
(2) Typical Relative Luminous Flux vs. Forward Current



(3) Typical Allowable Forward Current with Ambient Temperature

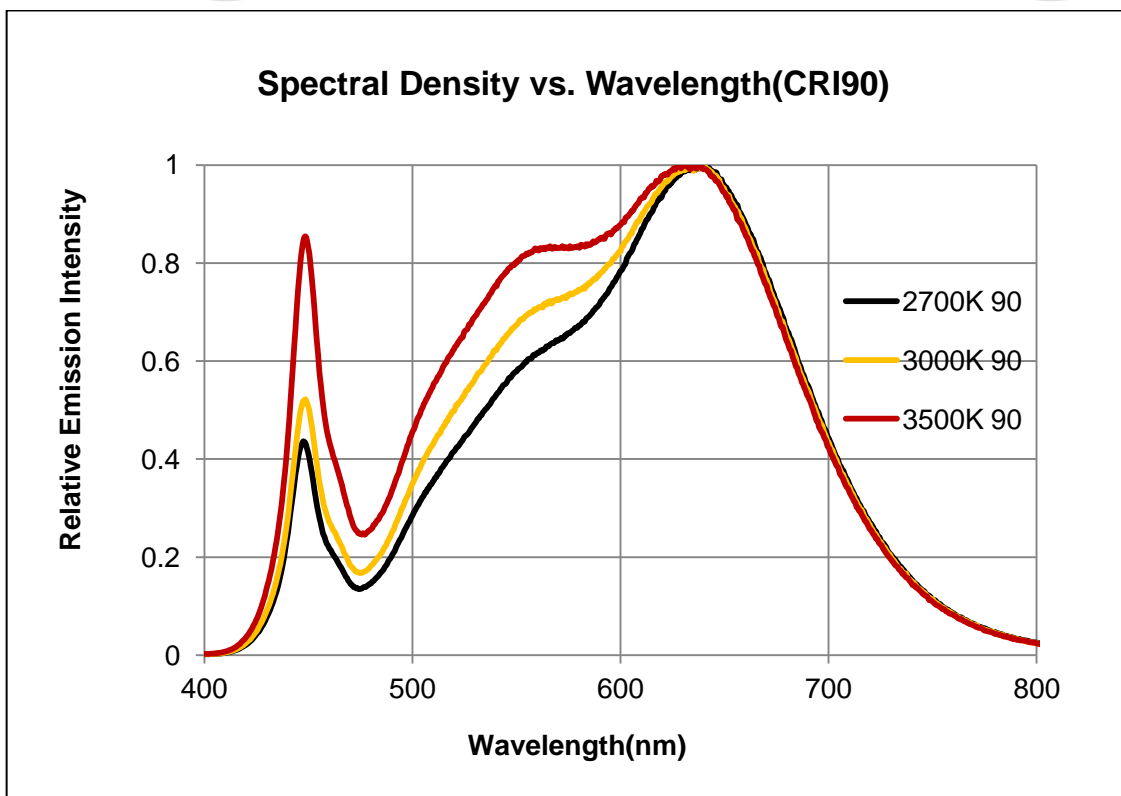
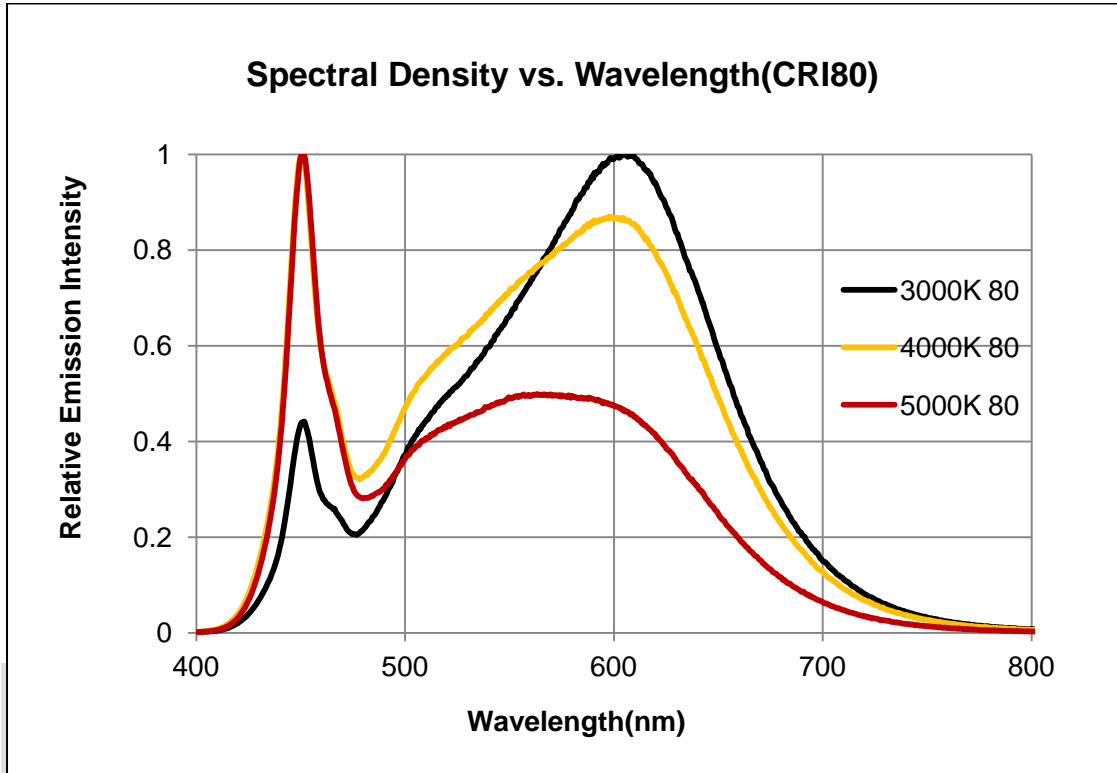


(4) Typical Spatial Radiation Characteristic





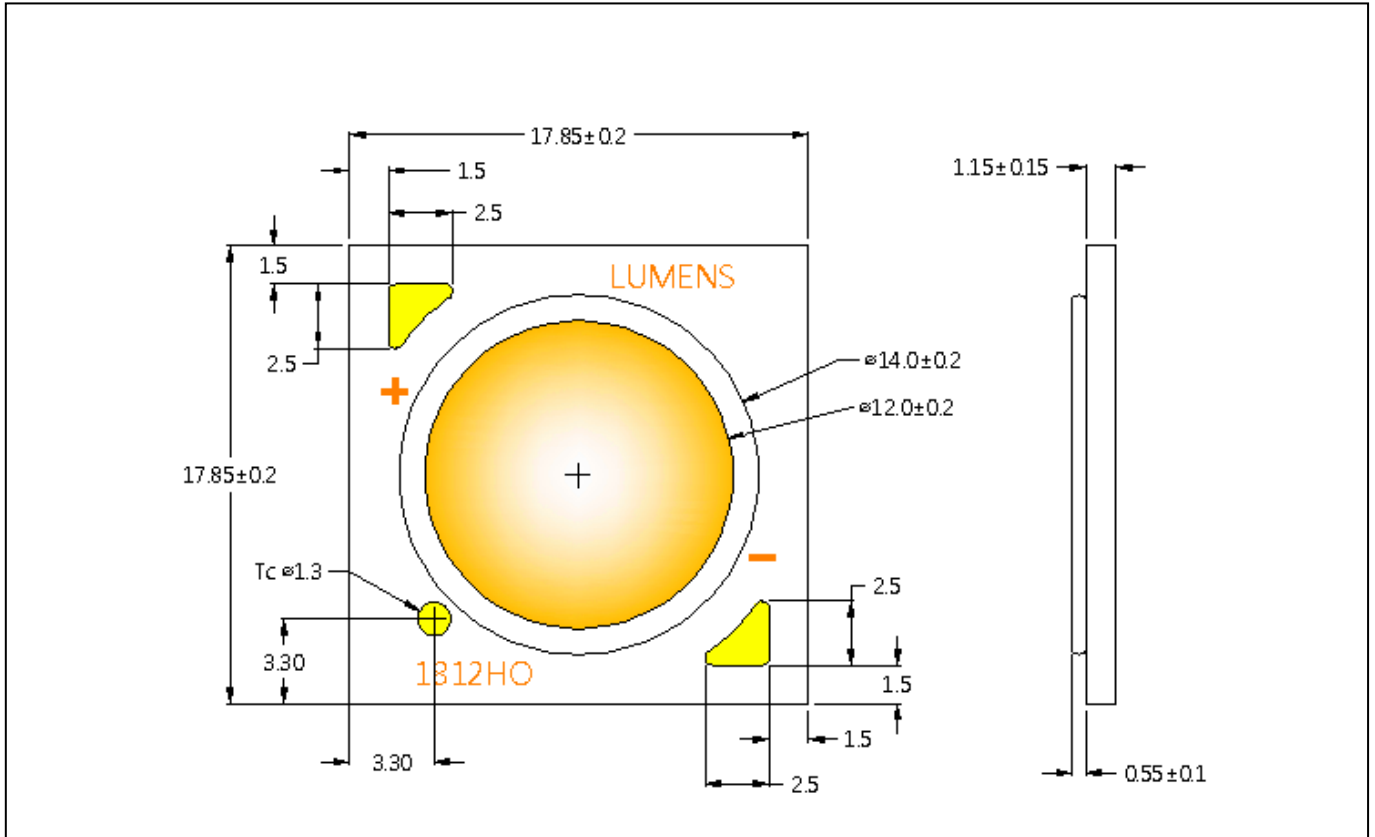
(5) Spectrum



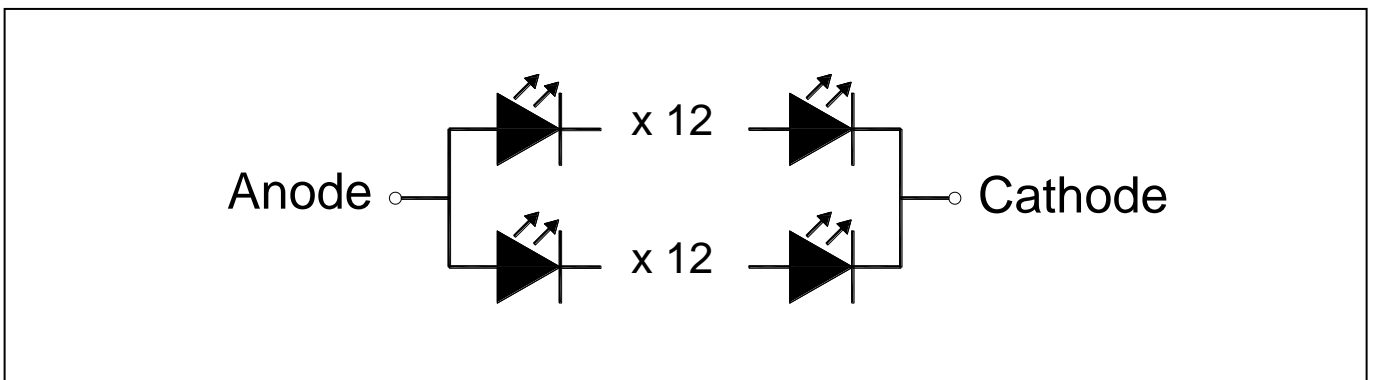
### 8. Outline Dimensions

- Package outline (Width x Length x Height) of 17.85 x 17.85 x 1.70mm
- Undefined tolerance is  $\pm 0.2$  mm

(Unit : mm)

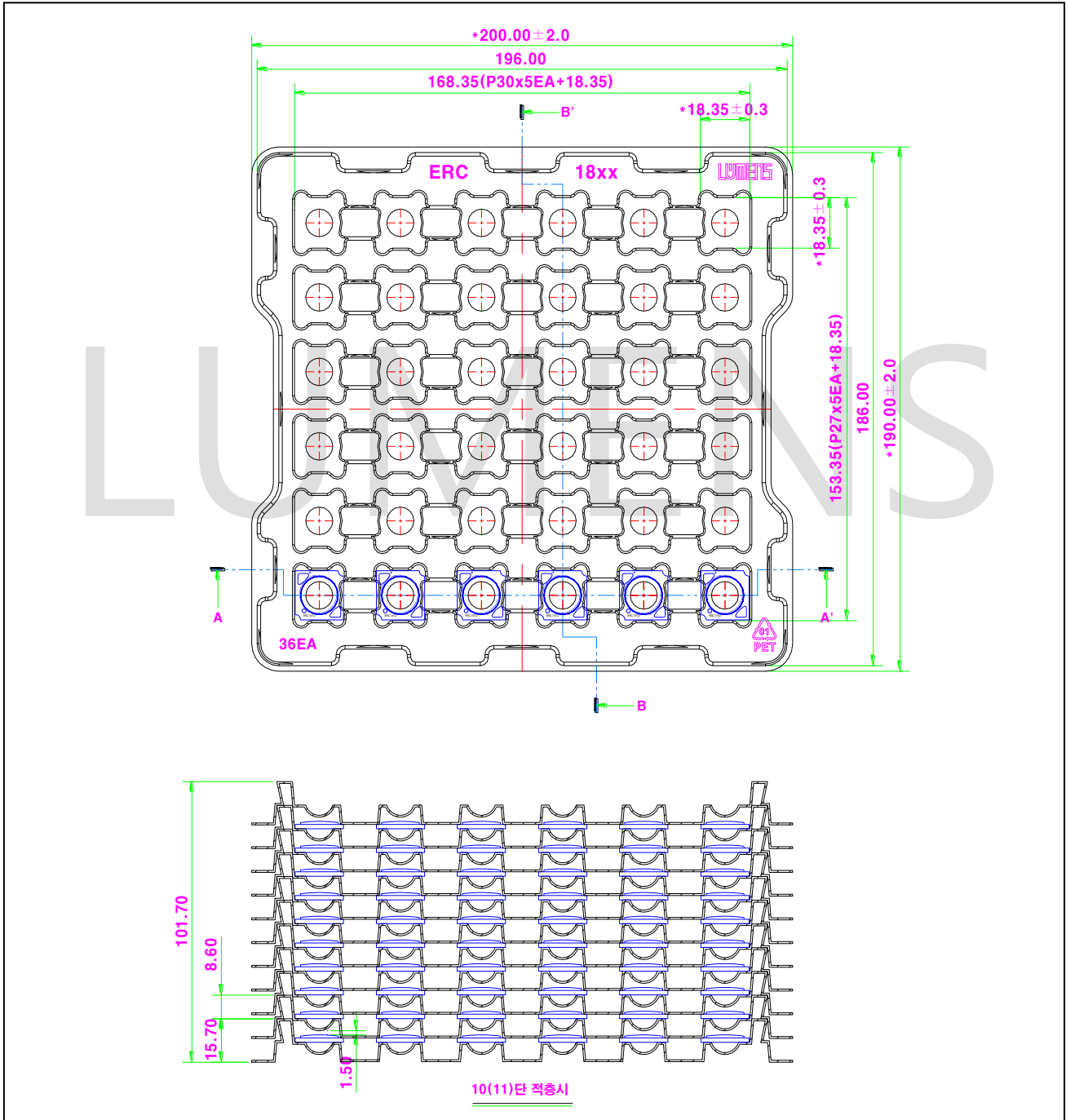


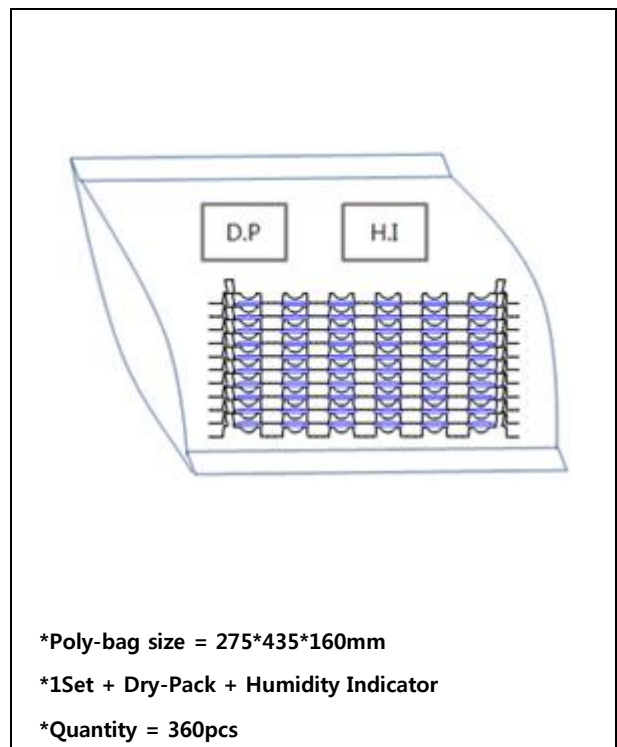
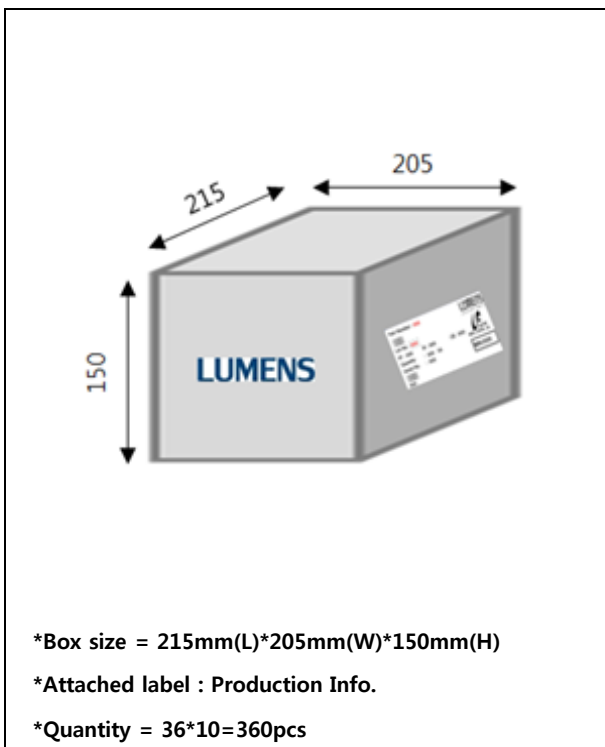
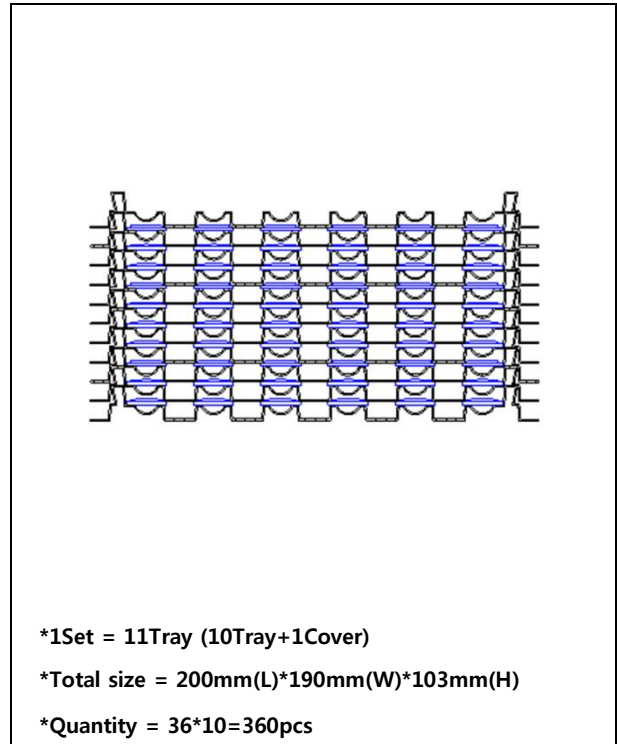
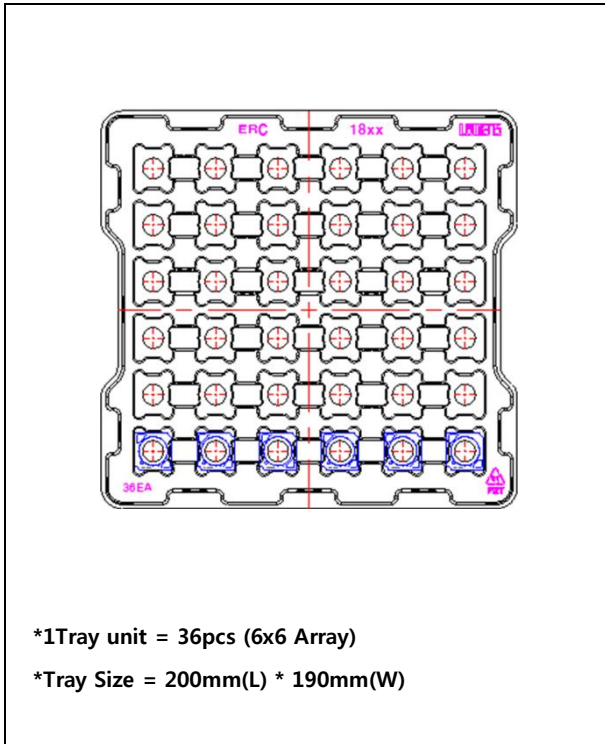
### 9. Circuit Design



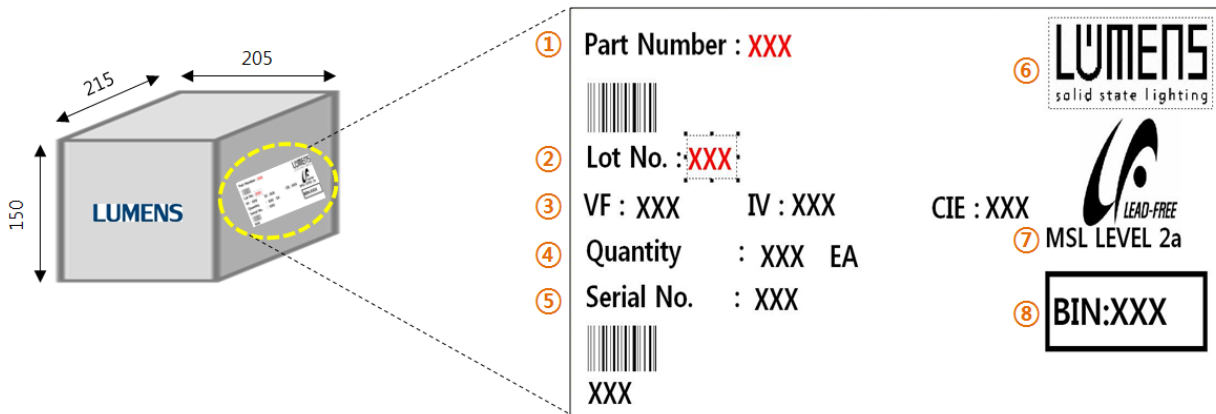
### 10. Packing

- 36pcs modules per tray
- 10 trays in one Carton
- Tray Size: LxW=200 x 190(mm) 6X 6=36pcs.
- Carton Size: 215mm x 205mm x 150mm
- Undefined tolerance is  $\pm 2$  mm





## 11. Label Format



No.	ITEM	REMARK	DESCRIPTION
①	PART NUMBER	ECxxxxxxxxxx - xxxx	EC : Ergon COB (Series, Size, Type, Color, CRI, CCT, VF)
②	LOT NUMBER	xx-xxx - YYMMDDW -Lxxx	Production Input (Input date, Product model size, Lot no. ) Y(Year), M(Month), D(Day)
③	VF / IV / CIE	VF : Forward voltage IV : Luminous flux CIE : CCT+CRI	VF : xx - xx IV : xx - xx CIE : 827(2700K+80Ra)
④	QUANTITY	xxx EA	Total Q'ty
⑤	SERIAL NUMBER	xxx-YYMMDD	Y(Year), M(Month), D(Day)
⑥	COMPANY LOGO	LOGO	-
⑦	MSL LEVEL	Moisture Sensitivity Level	ex) MSL1 ~ 6
⑧	BIN No.	00xx ~ 90xx	TEST Bin No.

## 12. Reliability test items and conditions

Item	Reference	Test Conditions	Duration Cycle
Thermal Shock	EIAJ ED-4701	Ta = - 40°C (30min) ~ 100°C (30min)	100 Cycle
Operating Endurance Test	Internal Reference	Ta =25°C, IF = 330mA	1000 Hours
High Temperature High Humidity Life Test	Internal Reference	85°C, 85% RH	500 Hours
Low Temperature Storage Test	Internal Reference	Ta = -40°C	1000 Hours
High Temperature Storage Test	Internal Reference	Ta = 100°C	1000 Hours

### (1) Criteria for judging the damage

Item	Symbol	Condition	Criteria for Judgment	
			MIN	MAX
Forward Voltage	Vf	If = 330mA	-	USL (1) × 1.1
Luminous Intensity	Φv	If = 330mA	LSL (2) × 0.7	-

- USL : Upper Standard Level
- LSL : Lower Standard Level

## 13. Cautions

### (1) Moisture-Proof Package

- 1.1 When moisture is absorbed into the LED package it may vaporize and expand products during soldering. There is a possibility that this may cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture-proof package is used to keep moisture to a minimum in the package.
- 1.2 A package of a moisture-absorbent material (silica gel) is inserted into the shielding bag. The silica gel changes its color from blue to pink as it absorbs moisture.

### (2) Current limiting

A resistor should be used to limit current spikes that can be caused by voltage fluctuations. Otherwise damage could occur.

### (3) Storage Conditions

- 3.1 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture-proof packaging with moisture-absorbent material (silica gel) is recommended.
- 3.2 After opening the package: The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, they should be stored in moisture-proof packages, such as sealed containers with packages of moisture-absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture-proof bag and to reseal the moisture-proof bag again.
- 3.3 If the moisture-absorbent material (silica gel) has faded away or the LEDs have exceeded the recommended storage time, baking treatment should be performed using the following conditions.  
Baking treatment: more than 24 hours at 65±5°C
- 3.4 Lumens LED electrode sections are comprised of a silver-plated copper alloy. The silver surface may be affected by environments which contain corrosive gases and so on. Please avoid condition which may cause difficulty environments during soldering operations. It is recommended that the user uses the LEDs as soon as possible.
- 3.5 Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

### (4) Handling of Silicone (Lens) LEDs

- 4.1 Avoid silicone resin parts especially with sharp tools such as tweezers.
- 4.2 Avoid leaving fingerprints on silicone lens part.

(5) Usage

5.1 Do not exceed the values given in this specification.

LUMENS

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